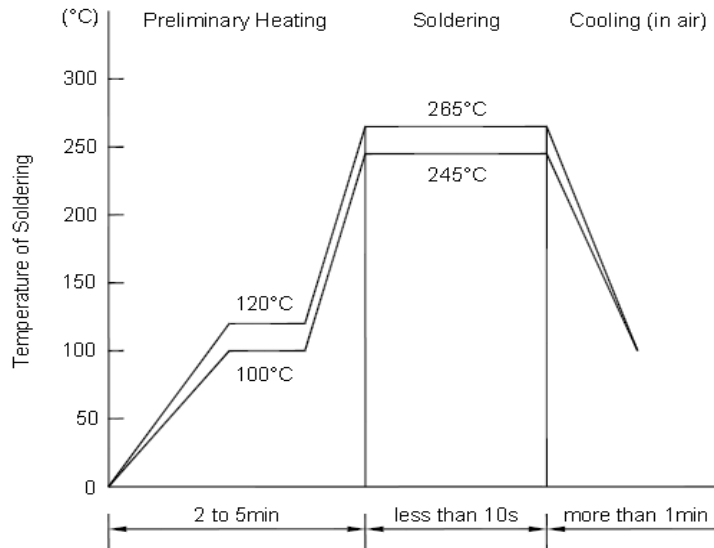
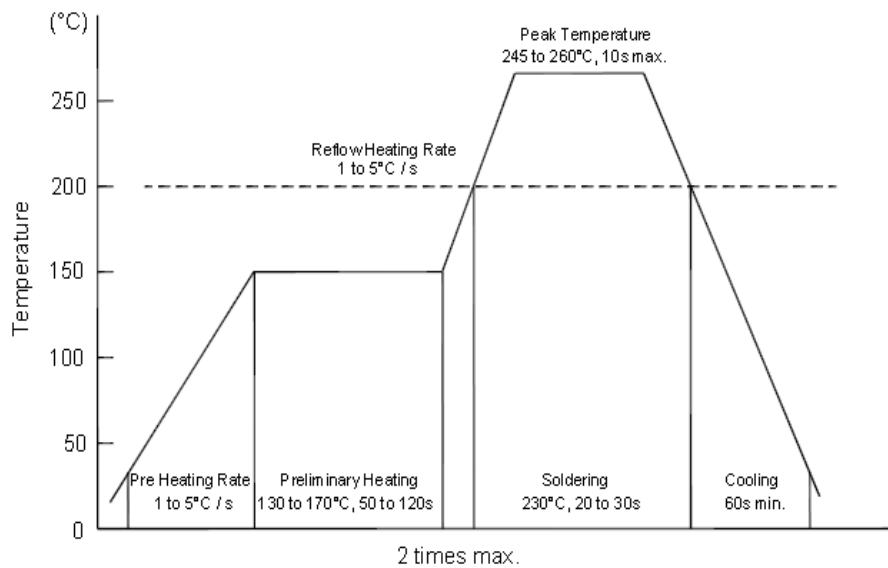


• Recommended condition of flow soldering



• Recommended condition of reflow soldering



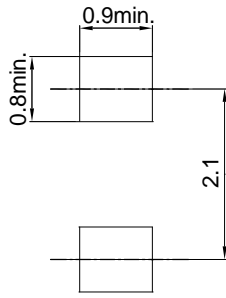
Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of solder paste (thicker)

• Condition of hand soldering

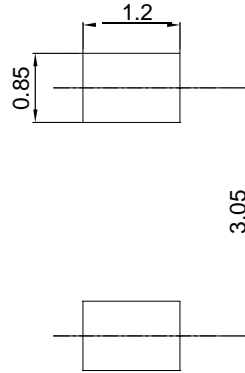
Temperature: 370 °C  
 Time: 3 s max.  
 Times: one time

• Remark: Lead free solder paste (96.5Sn/3.0Ag/0.5Cu)

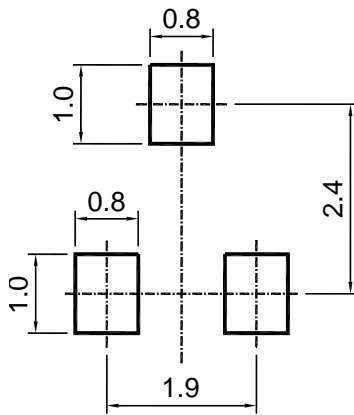
Units: in mm



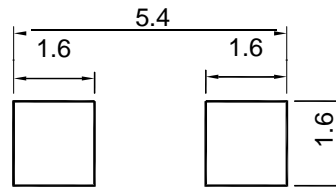
SOD-323



SOD-123



SOT-23



LL-34 (Mini MELF)